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(54) METHOD FOR MEASURING AND EVALUATING ULTRASONIC TEST PULSES

(?)) We, THYSEN NIEDERRHEIN AG
HUTTEN- UND WALZWERKS, a Campany organized under the laws of the Federal
bottom of the plate. Figure 1b shows the reRepublic of Germany, of 42 Oberhamsen,
Essoures Strasse, 66 Germany, do hereby dedare the invention for which we pusy that a
patent may be granted to us, and the method
by which it is to be performed, to be particuby which it is to be performed, to be particuby which it is to be performed, to be particuby when the mis a defect in the

This invention relates to a method for measuring and evaluating ultrasouch test pulses of a selected pulse repetition frequency in the ultrasouch testing of plates and similar 15 testpices in accordance with the pulse-edno method with a plantilly of Si (ransantiset, receiver) test probes, where the defect etho and the hottom echo are dispred with the pulse through the test piece; the defect echoes are standardised on the bottom choes and their probe and the time the pulse takes to travel through the test piece; the defect echoes are standardised on the bottom choes and their probe and the time the pulse through the standard on the bottom choes and their probe and the time the pulse through the standards on the bottom choes and their and the standards the pulse through the standards of the bid described which to those methods of the bid described which are already known from practice. In order to a make these understandable and to explain

let us first state the following:

In the pulse-cho method using SR tests
probes (SR=separate transmitter and reorders), appeared the full second pulse of a
selected repetition frequency are transmitted
into the test piece and the reflections are
picked up by a separate receiver. By means
of the second of the second of the reflection of the
figure 1a is outlined the principle of an SE
probe when testing a plate. The pulse passes
first from the transmitter through a path of
synthetic material, and is introduced fine the

the problem on which the invention is based,

synthetic material and is introduced into the obtained, that is to say to discover whether be plate via a water film. Reflections of the pulse the material is free from defects or is affected take place at the top surface of the plate — by them. In order to arrive at this informa-

eabo"— and also at the edect; and if the bottom of the plate. Figure 1b shows the effectogram for this, with the transmitted pulse, 50 the top coupling scho, the defort choe and the bottom ocho. The time from the pulse being transmitted up to the bottom echo. The time from the pulse being transmitted up to the bottom echo being received corresponds to the total travel time of the pulse. When there is a defect in the start piece the pulse is entirely or partly reflected at the surface of the defect. In every case defect echoes have a shorter travel time then bottom echo and therefore they lie whilsh the travel time through the test piece. Of This latest time is designanted here as the "mose of expected different". The beginning of the bottom of the defect of the pulse travel time through the complete of the pulse and the top coupling the contract of the pulse and the top coupling school corresponds to the pulse travel time in the test piece of a lauvon thickness of can be cancely

calculated from the formula $t_{x} = \frac{2d}{t_{x}} \qquad \qquad 70$

with the known speed of 5000 of 60000000 mg. For example, the travel time of an ultrasonic pulse in a 20 mm thick plate amounts to 674 st. The travel times in the path through the symbotic material and in the 750 meters flux are different from one SR probe water flux are different from one SR probe on a count of the wear which takes place in operation. The preliminary travel time of usual probes lies approximately between 15 80 and 20 µs.

In the evaluation of an ultrasonic pulse it is a requirement that as east details as possible on the quality of the material through which the ultrasonic field passes should be obtained, that is to say to discover whether the material is free from defects or is affected by them. In order to arrive at this informa-

tion, the amplitude levels of the defect echo and the bottom echo must be measured. For this it is necessary to separate these echoes from the sequence of reflections and display 5 them. Therefore, the first part of the task is to form time gates, as sketched in Figure 1b - FE (defect echo) display and RE (bottom echo) display. At the same time, the unit for producing the gates must first of all be able to be controlled via a computer according to the given thickness of the test piece, and the given inicials of the test piece, and secondly, the position of the defect gates with-in the travel time of the pulse must be able to be automatically controlled from one pulse 15 to the next, so as to take into account the individual lengths of the preliminary paths of a number of probes and how they have or a number or probes and now they have been affected by wear. Therefore, with the solution of this problem there is also compled the necessity of a high speed of control. According to the display of the defort echo and the bottom echo their amplitude levels can be measured. These measurements must take place for each individual test pulse, and 25 therefore at a high speed. The absolute level of the defect echo is still not a direct measurement of the size of a defect situated in the ultrasonic field, as the echo level is essentially also dependent on two groups of in-30 fluencing factors.

The first group is connected with the generating, the spread and the reception of the ultrasonic field. The level of the defect echo is dependent on:

the sensitivity of the SE probe.

the couplant conditions, and also the distance of the defect from

the SE probe.

The second group covers the values which
to relate to the nature of the defect, such as:

the shape of the defect, the reflection coefficient,

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the characteristics of the surface of the defect, and

the inclination of the plane of the defect to the ultrasonic beam.

From what has been said it follows that the next task is to eliminate the aforesaid influencing factors in a suitable manner.

In the first group of influencing factors, the level of the defect echo has to be related to the bostom echo level in order to compensate for the differences in sensitivity between the level in the deference in sensitivity between the level in the sensitivity and the influence of the level in the sensitivity and the influence and influence and the complaint between the probe and on the couplaint conditions in the defect echo. Thus group dence of the defect echo. Thus group dence of the defect echo in the bottom chen on the distance away of the defect must be distinated by a correction of both echo the distance away of the defect must be distinated by a correction of both echo the distance away of the defect must be distinated by a correction of both echo

The influencing factors in the second group relating to the mature of the defect can be taken into the intellection of the control of the defect can be taken into the intellection of the defect can be defected by the defect of the defect of

After eliminating the influencing factors of the first group, the task is concluded by carrying out the determination of the size of the defects by means of discriminators.

The generation of ultrasonic pulses and the reception and display of the reflections have long been known technically. The evaluation of the ultrasonic pulses, i.e. seeking out the information contained with due account being taken of the aforesaid influencing factors of the first group, can be carried out by an observer with the help of indicating instruments such as, for example, an oscilloscope or ultrasonic testing instruments which can be compared to specialised oscilloscopes. This kind of evaluation has the decided disadvantage that it is very time-consuming and can be carried out only statically, so to speak. For objective, automatic ultrasonic testing, what are known as "monitors" are used these forming part of the present state of the art. These monitors produce the time gates for the zone of expected defects, and also for the bottom echo. This gate control has the disadvantage that it can be adjusted for the preliminary path and the thickness of the material only by hand or by means of a relatively slow-working control system. When several SE probes are being used, it is a disadvantageous requirement that all the SE probes must have similar preliminary paths. The monitors also have one or more trigger thresholds for discriminating the defect 110 echoes which are found.

For compensating for the sensitivity of the probe and variations in the couplant conditions by relating the defect echo to the bottom echo, the already known "gain constitution" method is used. In this way of controllment amplifier a certain number of bottom echo the suppliers a certain number of bottom conditions are constituted as the supplier of the suppliers of the suppliers and the amplification for the successful and the amplification for the successful and the suppliers of the suppliers

V=amplification; G=size of defect) are based.

This method of standardising the defect echo on the bottom echo has, however dis-5 advantages: the regulation is by its very nature relatively sluggish. In order to obtain an average value by integration, experience has shown that some 10 pulses are necessary. Sudden alterations in the couplant condition 10 cannot be dealt with by this type of regula-tion. This kind of regulation always demands extrapolation of previous pulses onto the suc-ceeding ones, and reflections from separate

places. It is true that for compensating for the depth characteristic curves, automatic elec-tronic methods have been known, in which the amplifiers are controlled with given characteristics according to the pulse travel 20 time. However, any desired complicated characteristic curve functions, such as are found with SE probes, cannot be compensated. Besides this, account is not taken of the fact that the characteristic curves for defect echoes 25 differ from those of bottom echoes, as the

echoes obey different laws. To sum up, there are the following disad-vantages and failings in the known methods and instruments for solving the problem pre-

viously described: The creation of short time gates, which are necessary for displaying the defect echo and the bottom echo, is, as regards their position and duration, only possible by hand or by slow-working control cir-cuits. With this, it is necessary to have the same preliminary paths for all the 35 SE probes used. It is not possible to take direct account of wear on the probes. Therefore the maintenance expenses for a number of SE probes become un-

hearably high.

The method of standardising onto the bottom echo, the so-called "gain control", is too sluggish. It does not take into account the pulse which is actually travel-ling and which should be used for the measurement, but relies on pulses which are separated from this in both time and place, the result being that for the reference value there is obtained an average

Defects which are situated close to the surface, and also the kind of defect in which only slight reflection takes place, are not indicated when the gain control 55 is based on an undisturbed bottom echo. If the gain control relies on the bottom echo being disturbed by the defect, then 6N there are the disadvantages that in the first place each individual SE probe must have its own gain control unit, and secondly that the indication of the kinds of defect just mentioned is uncertain, sulting a table stored in an electronic memory, because of the sluggishness of the this table being programmed with a corres-65

method. There is no automatic ascertaining of the depth at which the defect is situated, nor any compensation of the defect echo and the bottom echo in accordance with whatever depth characteristic curve is associated with the probe.

Looked upon as a whole, therefore, there is so far neither method nor apparatus known with which the requirement laid down at the beginning could be conclusively solved, nor does a combination of the separate, known

does a commonation of the separate, known parts of methrids satisfy the requirement. Against this, the problem on which the invention is based is to develop a method for the automatic measuring and processing of ultrasonic pulses, particularly suitable for use in ultrasonic testing equipment with a number of SE probes and electronic data processing of the problem of the processing of the problem of the problem of the processing of the problem of the pr sing equipment, in which the aforesaid dis-advantages and failings of known parts of 85 methods are avoided.

According to the present invention, there is provided a method for measuring and evaluating ultrasonic test pulses of a selected pulse repetition frequency in the ultrasonic testing repetition incidency in the intrasount tearing of plates and similar test pieces by means of the pulse-echo method with a plurelity of SE (as hereinbefore defined) test probes, where the defect echoes and bottom echoes where the defect echoes and bottom cenoes are displayed within time gates, taking into account the preliminary path of the pulse through the probe and a coupling medium and the time the pulse takes to travel through the test piece, the defect echo ampliandes being standardised by the bottom echo ampliundes and the defect echo and bottom echo amplitudes being measured and corrected as dictated by the associated characteristic echoamplitude compensation-depth curves, by taking into account the travel times, wherein 105 the preliminary paths of all the SH probes are individually and successively ascertained automatically in time with the pulse repetition frequency by counting out the total pulse travel time from transmission of a pulse to reception of a bottom echo with a high counting frequency and electronically obtaining the differential between the total pulse travel time and the pulse travel time solely through

time gates being created by counting out at the aforesaid counting frequency; the maxi-mum amplitudes of the maximum defect echoes and of the bottom echoes being auto-matically determined for each pulse and being digitally stored in a corresponding echo level memory, the travel time of the maximum defect echo per pulse being established by automatically counting out the counter fre- 125 quency; the corrections of the defect echoes according to the travel time being carried out by using the travel time as a director for con-

the test piece and storing the preliminary paths in a memory as a number of oscillations: the

characteristic curve function; and the standardising of the defect echoes by the associated bottom echoes being, by logarithmic measure-5 ment of the echo levels, reduced to a subtraction, this being performed by simultaneously counting out the echo level memories and ob taining the count differential, which is stored in a counter, the relationship of the defect

10 echo to the bottom echo being discriminated

by one or more thresholds,

By this, the relationship defect echo/bottom echo, or respectively their logarithmic differential, can easily be indicated in figures 15 and discriminated by means of digital comparators. The total travel time of the pulse, the pulse travel time through the preliminary path, the defect echo travel time and the bottom echo travel time can be stored in respec-20 tive memories in a binary code. The simplest way of creating the time gates is to take the stored preliminary paths of each SE probe and also the thickness of the test piece as the values which have to be counted out. Gener-25 ally in the method of the invention, the amplitudes of the maximum defect echoes and of the bottom echo will be digitally and loga-rithmically stored and indicated. The pulse travel time from the test piece surface to a 30 defect or to the bottom of the test piece too can be indicated in figures. Generally it is recommended that in addition a correction of the bottom echoes should be carried out by using the thickness of the test piece as the 35 director for consulting a table stored in a further electronic memory, this table being programmed with a corresponding characteristic curve function.

In other words, the invention by the above 40 features and by further features makes pos-sible as a whole;

the determining and storing of the pre-liminary paths of all the SE probes; the creation of time gates for displaying defect echoes and bottom echoes; the measuring of the amplitudes of defect echoes and bottom echoes;

the ascertaining of the travel times of the defect echoes

the correction of defect echoes and bottom echoes in accordance with given depth characteristic curves: the finding of the relationship of the

defect echo to the bottom echo the discrimination of the relationship of the defect echo to the bottom echo. The preliminary paths of all the probes are individually, successively and automatically ascertained, in time with the pulse repetition for frequency (up to about 20 KHz depending

on the thickness range of the plates), by counting out the pulse rravel time with a high frequency (about 30 MHz) and obtaining electronically the differential between the total

65 pulse travel time and the time the pulse takes slight reflections occur because of sound-ab-

ponding echo-amplitude compensation-depth to travel through the test piece and are stored away in the binary code as a number of oscillations. After that, the creation of the time gates is done likewise by counting out the aforesaid high frequency, the stored prelimi-nary paths for each probe and also the test piece thickness being used as the values to be counted out. The determination of the amplitudes of the maximum defect echo and of the bottom echo is automatically carried out practically simultaneously for each indi-vidual pulse, the measuring being done digitally and logarithmically, e.g. in dB, and the measurements being stored and indicated in figures. When the pulse voltage rises there is also given, per dB stage, a signal for determin-ing the travel time. Ascertaining the travel time of the maximum defect echo per pulse is likewise done by counting out the aforesaid high frequency, the last of the signals just mentioned marking the end of this travel

The travel time is indicated in figures. The correction of defect echoes according to the depth of their position is carried out by means of the measured travel time by using

the latter as the director for consulting a table stored in an electronic memory, this table being able to be programmed with any desired characteristic curve function. The correction for the bottom echoes is carried out in a second table, correspondingly program-med, and in this case the test piece thickness is used as the director. The dividing of the

defect echo level by the bottom echo level 100 is reduced to a subtraction because the echo levels are measured logarithmically; this is done by simultaneously counting out the con-tents of the echo level memories, controlled in such a way that the differential between 105 the levels is fixed in a counter. The reference

value of the relationship is therefore the bottom echo affected by the defect. The relationship or defect echo/bottom echo, or respectively their differential, in dB, is indicated in 110 figures and directly discriminated by means of any desired number of digital compara-

The result is first that all the disadvantages of the known methods are obviated, and the 115 problem on which the invention is based is solved. By relating the defect echo to the defect-disturbed bottom echo for each indidetect-insurped bottom cuto not each indi-vidual testing pulse there is also a particularly outstanding advantage, for even those defects 120 are indicated which produce only a slight echo but which cause the collapse of the bottom echo because of their shadowing effect.

The fact is that when the reference value be-comes very small, the defect echo too can be 125 correspondingly small. This includes defects which are situated very close to the surface and which therefore lie in the dead zone, and also those kinds of defect in which only

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sorption, but in which the bottom echo is The gate control. completely absorbed.

An advantage of the through-transmission method is obtained, without having to put up 5 with the disadvantages. The invention als covers, in case it is desired or necessary for other SE probes or test pieces, using the undisturbed bottom echo as the reference.

The question of whether relating the defect

10 echo to the disturbed bottom echo results in a usable relationship, which makes possible an unambiguous determination of the size of defects, may be answered by means of Figure 2. Figure 2 shows the curve for the depth-15 corrected echo level ratio of the defect echo

to the disturbed bottom echo. Different depths of defect were selected as the parameters. The thickness of the test piece was 24.6 mm. The bottom echo correction is standardised on the 20 bottom echo of a plate of 18 mm, because the focus point of the probe lies in 18 mm depth. It can be seen from Figure 2 that up to a defect of 4 mm the standardised curves

do not deviate appreciably from each other. 25 If therefore a threshold is set — as is customary in practical testing — at about 3 to 4 mm plain drilled hole, this has the same value for every defect position. When the defects are larger the curves part from each
other, in particular the curve for the mid
position (12.3 mm) shows a great deviation
because in this case the second defect echo,
instead of the bottom echo takes over the

role of the reference value. However, it is of no interest here beyond giving a general indication to known how the curves run above the threshold value.

The invention will now be described in greater detail, by way of example, with refer-40 ence to the accompanying drawings, in

Figure 3 shows schematically the functional construction of an ultrasonic pulse measuring and calculating instrument according to the 45 invention;

Figure 4 shows the principle of the gate control for the instrument of Figure 3.

Figure 5 is a schematic explanation of the determination of the amplitudes of the defect 50 echo and bottom echo and also of the standardising, and Figure 6 is a schematic explanation of the

depth curve compensation. The measuring and calculating instrument, 55 represented in Figure 3 contains the following functional units:

The governing equipment: This is the pacemaker of the whole instrument and essentially contains components 60 which reduce a given timing frequency, which here is 30 MHz, to the different low control frequencies necessary for the gate control.

In this block are created the necessary time gates for displaying the zone of expected defects and the bottom echo. It is from the gate control that the two groups of functions i.e. travel time measurement and echo level measurement are controlled.

The echo level measurement, In this unit, which is directly connected to the receiving side of the SE probe, the defect echo levels and bottom echo levels are

measured.

The relationship formation.

Here the echo level ratio between the maximus defect echo and the bottom echo of one and the same pulse is formed.

The travel time measurement,

Here is measured the travel time of the defect pulse from the moment the injected pulse enters the top of the test piece until the largest defect pulse reaches its maximum,

The depth characteristic curve compensation. In this unit is determined the depth correction for the defect echo level, based on the ascertained travel time, and also the correction for the bottom echo level, based on the given plate thickness. The two correction values are passed on to the relationship forma-tion unit during the relationship formation and before the end of the pulse travel time.

The defect discrimination.

This stage consists of any desired number of adjustable threshold values in the form of digital comparators. The "Yes-No" information from the digital comparators is passed on to the computer.

The governing equipment contains a 30 MHz oscillator. From this frequency are derived all the timing frequencies necessary for rived at the timing frequencies necessary for controlling the counters, memories and regis-ters (see below). By means of a multiplexer, for each individual SB probe in succession not only are the pulses released but also the preamptifier for the relevant receiver is switched-in. In addition, with the same tim-ing, the preliminary path memory is activated for giving out the corresponding preliminary

path time. The problem of the gate control first raises the question of the method of time measurement. Time measurement of any desired accuracy can be achieved by using a corresacting can be achieved by using a conse-pondingly high frequency. In the present case, of course, a very high counting frequency is used, as can be seen from the extremely short pulse travel times (6.74 μ sec for a test piece thickness of 20 mm). If the defect gate set-

ting is required to have a resolution of 0.1 mm in a steel test piece, the result is a counting frequency of about 30 MHz — that is to say

one 30 MHz escillation corresponds to the pulse travel time through 0.1 mm of steel, there and back. The principle of the gate control is shown in Figure 4. The start of each individual testing operation is initiated by the transminer pulse. Fundamentally, as soon as the pulse dies away at the transmitter the monitoring display could be opened, and closed again shortly before the bottom echo. 10 However, in view of possible interference by electromagnetic pulses the display time should be as short as possible. Therefore, the gate is not opened until after the expiry of the preliminary travel time, as is shown in Figure 4 on the left. This means that the preliminary travel time must be exactly known. But this depends in each individual case on the SE probe and on the wear which has taken place, Therefore it is necessary regularly to deter-20 mine the amount of the preliminary path time, which here is designated as t, By measuring the travel time on a test piece of known thickness this time can be ascertained by subtracting the travel time through the 25 test piece e.g. steel plate, which can be cal-culated exactly and is here shown as t_{sts} from the measured total travel time ters. There are two distinct operational phases, namely the measuring phase - shown in Figure 4 to the 30 left of the dashed line - in which the preliminary path of each individual probe is ascertained by means of a test piece and stored in a memory, and the testing phase — on the right in Figure 4 — in which during 35 the testing operation, separately for each individual SE probe, the gates are formed from the values stored in the memory and from

the thickness of the test piece e.g. the plates being examined. In the measuring phase the 40 SE probes are applied to a test plate of a known thickness. The given test plate thickness is pre-set in a counter - here designated as the "preliminary path counter, for-wards" — as the amount to be subtracted 45 in the formula written on the diagram, that

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is to say (-t, t). In practice this is done in such a way that tet is set as the complement to the maximum counting capacity of the counter. If, for example, the maximum count-50 ing capacity is 10,000, then in the case of a test plate thickness of, for example, 20 mm, corresponding to 200 oscillations of the generator, the counter is set to 9,800. The govern-

ing equipment releases the transminer pulse and simultaneously starts up the "preliminary path counter, forwards". This runs in the forward direction. As it was pre-set negatively, it runs up to 10,000. When it reaches its maximum counting capacity it has therefore 60 counter 200 oscillations, that is to say the travel time for the test plate thickness. The

further counting period up to the bottom echo now corresponds to the preliminary path. After the bottom echo has stopped the coun-

65 ter, the time t., corresponding to the pre- appear at the receiver, but in most cases it is 130

liminary path, is present in the counter. It is immediately taken up into the preliminary path memory, which is made as a shift register. In the same way the preliminary paths of the other SE probes are measured and stored in the memory. With this, the measur-ing phase is concluded. Corrections of the gate times to take into account the leading edges of the bottom echoes and also the tolerances on the test plate thicknesses are car-ried out by means of the already known value for the thickness of the test plate.

In the testing phase the time gates are formed by a chain of counters which are set up with suitably different counting times. Each counter counts out its pre-determined time, and after its "count down" starts up the next counter. First of all the "preliminary path counter, backwards" is set to the preliminary path of the first SE probe and is

then started up by the governing equipment, at the same time as the transmitter pulse. This counter runs backwards. When it reaches zero, the preliminary path has been counted down. A pulse is given out by the counter by which the defect gate is opened, that is to say at the end of the preliminary path — which is equivalent to the beginning of the which is equivarian to the organizing of the zone of expected defects. But this pulse also simultaneously starts up the "plate thick-nesses counter". This is set to the thickness of the place being examined at that time. When this counter reaches zero the defect gate is closed, and simultaneously a "dead gap counter" is started up. The dead gap produced here between the defect gate and the bottom echo gate is necessary for the control operations for the measurement of the echo levels. After the "count down" of the dead gap counter the bottom echo gate is started up, and the bottom echo gate is counted down by the "bottom echo gate counter" in a manner corresponding to the previous time gate formations. For controlling the echo level measuring unit the time-gates for the 110

are shown in Figure 4 at the top right hand In Figure 5 are illustrated the various steps for measuring the echo levels, the formation of the relationship between the defect echo and the bottom echo, and the defect discrimination. The pulses picked up by the receiver are first amplified. Below the receiver there is the pulse diagram of a single ultrasonic probing operation, with the transmitter pulse. the top coupling echo, the defect echo and the bottom echo being indicated. The ultrasonic oscillations are in this case not rectified, Actually, the transmitter pulse might not

defect echo (FE) and the bottom echo (RE),

each individually, and a through-going time

gate from the start of the zone of expected

defects up to the end of the bottom echo

are still needed. These gate configurations

present as electro-magnetic coupling. From rises and flop back, as the pulse passes on, the time standpoint this sequence of echoes enters the amplifier in the reverse order from what is shown here, which has been done to 5 take account of the customary display on the oscilloscope. The amplified signals are passed on to a chain of comparators. This chain of comparators serves as a rapid digital voltmeter. The measuring unit consists of 80 10 comparators which, like trigger stages, flip over when a fixed pre-set reference voltage is reached. In order to be able to reduce the

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subsequent calculating operation, namely the division of the defect echo by the bottom 15 echo, to a subtraction which is simple to carry out electronically, the reference voltages are built up logarithmically by voltage dividers in such a way that they each differ from the next comparator by 1 dB. Thus the voltage 20 measurement is performed with an accuracy of 1 dB, which is fully adequate for ultrasonic purposes. The response speed of these comparators is higher by at least a factor of 4 than the leading-edge-rise-speed of a 4

25 MHz pulse. As an example, a bottom echo pulse is shown in the drawing in the comparator chain. The peak of the pulse, which was received at 4 dB, has caused all the comparators from 5 to 80 dB to flip over (0dB corresponds to an unwestered signal). Since, after the passage of the ultrasonic pulse, the com-parators slop back, the state of the compara-tor chain during the passage of the pulse is

retained by amplitude memories, which are 35 connected to the individual comparators. The peak voltage of the pulse is fixed in the memory. As shown in Figure 5 the memory is activated by the gate control only during the ranges where the defect echo and the bot-40 tom echo are to be expected. This memory for the amplitudes of the defect echo-bottom echo represents as it were an intermediate memory for the defect echoes and bottom echoes which arrive one after the other. It is

45 always discharged when there is no time gate present, and therefore in the dead gap between the defect echo gate and the bottom echo gate. The defect echoes and bottom echoes are separately stored in the corres-50 ponding 80 bit shift registers shown alongside, Each value in the memory is transferred simultaneously in a parallel manner. The transfer is controlled by the gate control unit (repre-sented symbolically in Figure 5 by the pulse

55 sequence FE gate/RE gate), by means of the defect echo gate in the case of the defect shift register and by means of the bottom echo gate in the case of the bottom echo shift register. At the end of the pulse travel there is, 60 in the defect shift register, the highest pulse

which has passed through the zone of expected defects, and in the bottom echo reg the height of the bottom echo pulse, both being digitally expressed in dB. Therefore, 65 whilst the comparators flip over as the pulse

the memories and shift registers retain the pulse peaks; each intermediate memory retains them only during the zone of expected de-fects and the time of the bottom echo gate respectively, but the shift registers still retain them after the expiry of the time gates. The echo levels are now read off in series

from the shift registers by means of two counters with a generator frequency of 15 MHz. The registers are counted down, starting with the low amplification values. Both counters are stopped by the first memory which holds a "yes" piece of information. The count down of both memories takes place simultaneously. Therefore, in the defect echo

shift register six empty memories are counted =6 dB, and in the bottom echo shift regis-ter four empty memories=4 dB. These mun-bars are visually indicated in figures. The count down of the echo levels is done as soon as the defect echo gate, the dead gap gate and the bottom echo gate no longer exist, this being symbolized in Figure 5 by the total gate pulse. With this the operation of echo level measurement, both for the defect echo and the bottom echo, is concluded. By means of an adjustable digital comparator, not shown in Figure 5, a minimum height for the bottom echo is monitored as a criterion for any

defect in the probe. In order to form the echo level ratio of the defect echo and the bottom echo, i.e. in order to carry out the standardisation, a further counter, here called the "relationship counter", is started by means of a start/stop logic as soon as either the defect echo counter or the bottom echo counter has finished counting the echo level. The relationship counter then counts out 15 MHz oscillations until the other 105

echo level counter has likewise stopped. It has therefore counted out the number of oscillations, i.e. 1 dB steps, which lie be-tween the defect echo and the bottom echo, and therefore calculates the relationship of the echo levels in dB. The mathematical sign for this relationship is quite simply given by determining whether the defect echo counter or the bottom echo counter has stopped first. The relationship in dB is indicated in figures, together with the mathematical sign. If the sign is negative the defect echo is smaller than the bottom echo. The relationship

counter is pre-set as shown in Figure 5, with a correction value from the depth curve compensation. In this case, therefore, the rela-tionship value is not 6-4=2, but 7, because in the example here it has been assumed that the correction value is 5,

Before the correction for the compensation 125 can be ascertained, the pulse travel time must be measured. The travel time measuring unit is so conceived that the determination of the time takes place at the point of the maximum defect echo level. In order to make this pos-

sible, the memory for the amplitudes of the defects calo and the bettom cho is amade in such a way that when the such a way that when the such a way that when the such a such as the such

point in time of the passage of the highest can peak By this is immediately given the most important pre-requisite for determining the travel time of the maximum defect echo. 15 As Figure 6 shows, this pulse is passed on to an acceptance memory which accepts, together with the pulse, the momentary couning state of a counter running at 30 MHz. This counter is started up at the berinning of

20 the defect display. Both the time organishe of the effect display. Both the time and the acceptance memory are only a few points of the defect gate (see "noe" in Figure 5). From the acceptance memory the Figure 5. From the acceptance memory the acceptance takes place at every pulse which causes the memory to fip over, i.e. even during the first time of an ultrasolar effection. Each previous value in the memory is cancellar by the acceeding one. Therefore, the

celled by the succeeding one. Therefore, the final pulse brings about the acceptance of the counting time which corresponds to the travel time of the pulse peak.

From the acceptance memory the time

value is passed on as a binary director to the 35 memory containing the defect characteristic curves. In this memory, elements which contain correction values for any required characteristic curve are available to the directors (the directors corresponding to the defect 40 depths). From this table, after the director has been fed in, the correction value is held in readiness at the output of the memory. Since the characteristic curves for the defect and for the bottom of the test piece are dif-45 ferent, a second similar memory is necessary for the characteristic curves of the bottom echo. This is programmed in such a way that the plate thickness coming from the computer is put in as the director, and the bottom echo 50 correction value in dB is held in readiness at the output. The two correction values are subtracted from each other in a subtractor, and the result, being the total correction value and the result, being the word conversed vanier and therefore the pre-setting for the counter, 55 is already prepared before the expiry of the total travel time of the pulse, that is to say already before the absolute value for the bot-

60 curve correction is concluded, both for paradiffer etchoic and for the bottom echoes.

The defect discrimination still remaining in Figure 5 is done by means of digital comparators. Here the relationship value is comparators. Here the relationship value is compared with threshold whose set digitally only to a subtraction, this being performed by

tom echo has been ascertained in the echo

level measuring unit. With this, the depth

hand or by computer, and when the threshold value is exceeded in any comparator stage it is recognised for a defect. The digital test information so obtained is passed on to a computer and may be displayed.

In the crample, the method as a whole is tailoard to the resting of plates; runsferring it to other types of test pieces is possible by changing the corresponding parameters. Although the instrument described for carrying out the method given in the invention is concived for computer-controlled installations, it can also be used in conjunction with simple recording equipment or for manual testing.

WHAT WE CLAIM IS:-

 A method for measuring and evaluating ultrasonic test pulses of a selected pulse repeplates and similar test pieces by means of the pulse-echo method with a plurality of SB (as hereinbefore defined) test probes, where the defect echoes and bottom echoes are displayed within time gates, taking into account the preliminary path of the pulse through the probe and a coupling medium and the time the pulse takes to travel through the test piece, the defect echo amplitudes being standardised by the bottom echo amplitudes and the defect echo and bottom echo amplitudes being measured and corrected as dictated by the associated characteristic and echo-ampli tude compensation-depth curves, by taking into account the travel times, wherein the preliminary paths of all the SE probes are individually and successively ascertained auto- 100 matically in time with the pulse repetition frequency by counting out the total pulse travel time from transmission of a pulse to reception of a bottom echo with a high counting frequency and electronically obtaining the 105 differential between the total pulse travel time and the pulse travel time solely through the and the pulse taken mine society through the test piece and storing the preliminary paths in a memory as a number of oscillations; the time gates being created by counting out at 110 the aforesaid counting frequency; the maximum and the society of the society o mum amplitudes of the maximum defect echoes and of the bottom echoes being automatically determined for each pulse and being digitally stored in a corresponding echo level memory, the travel time of the maximum de-fect echo per pulse being established by automatically counting out at the counting frequency; the correction of the defect echoes according to the travel time being carried out by using the travel time as a director for consulting a table stored in an electronic memory, this table being programmed with a corresponding echo-amplitude compensationdepth characteristic curve function; and the 125 standardising of the defect echoes by the associated bottom echoes being, by logarith-mic measurement of the echo levels, reduced

simultaneously counting out the echo level are stored and indicated digitally and logarithmemories and obtaining the count differential, which is stored in a counter, the relationship of the defect echo to the bottom echo being

5 discriminated by one or more thresholds. 2. A method as claimed in Claim 1, wherein the relationship of defect echo amplitude

divided by bottom echo amplitude, or respectively their logarithmic differential, is in-tio dicated in figures and discriminated by means of digital comparators.

3. A method as claimed in Claim 1 or Claim 2, wherein the total travel time of the pulse, the pulse travel time through the pre-

the bottom echo travel time are stored in respective memories in a binary code.

4. A method as claimed in any preceding Claim, wherein, when creating the time gates
the preliminary paths of each probe, stored
in a memory, and also the thickness of the test piece are used as the values which are to be counted out.

5. A method as claimed in any preceding 25 Claim, wherein the amplitudes of the maximum defect echo and also of the bottom echo

mically.

6. A method as claimed in any preceding O. A meaned as canned in any preceding. Claim, wherein the pulse travel time from the test piece surface to a defect or to the bottom of the test piece is also indicated in

7. A method as claimed in any preceding Claim, wherein a correction for the bottom Casm, wherein a correction for the bottom choice is carried out by using the thickness of the test piece as the director for consulting a table contained in a further electronic memory, this table being programmed with a corresponding eithe amplitude compession-depth characteristic curve function.

8. A method for measuring and substitution

8. A method for measuring and evaluating ultrasonic test pulses of a selected pulse repe-

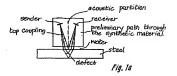
triton frequency in the ultrasonic testing of plates and similar test pieces substantially as 45 hereinbefore described with reference to Figures 3 to 6 of the accompanying drawings.

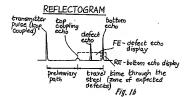
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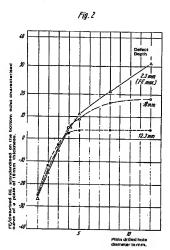
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TESTING SET-UP





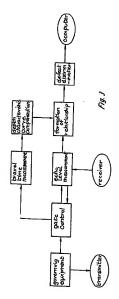
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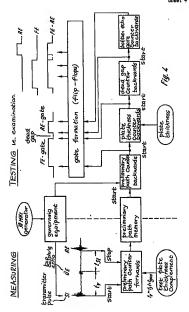
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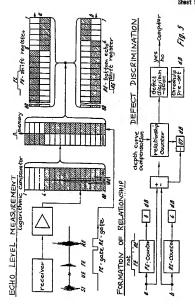


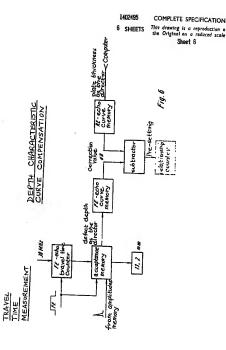
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